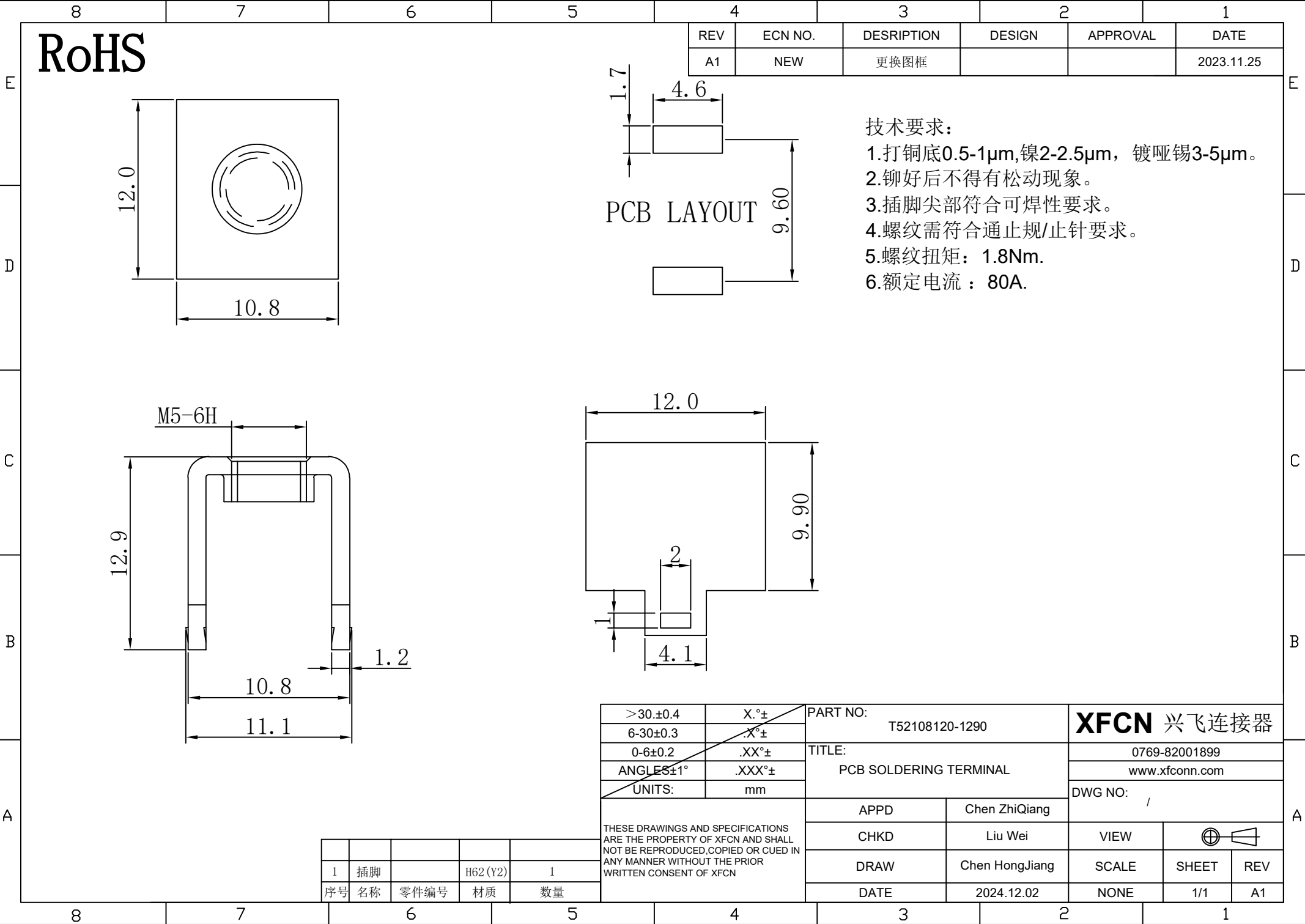


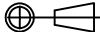


REV	ECN NO.	DESRPTION	DESIGN	APPROVAL	DATE
A1	NEW	更换图框			2023.11.25

- 技术要求:
- 1.打铜底0.5-1μm,镍2-2.5μm，镀哑锡3-5μm。
 - 2.铆好后不得有松动现象。
 - 3.插脚尖部符合可焊性要求。
 - 4.螺纹需符合通止规/止针要求。
 - 5.螺纹扭矩：1.8Nm.
 - 6.额定电流：80A.

PCB LAYOUT

>30.±0.4	X.°±
6-30±0.3	.X°±
0-6±0.2	.XX°±
ANGLES±1°	.XXX°±
UNITS:	mm

PART NO: T52108120-1290		XFCN 兴飞连接器		
TITLE: PCB SOLDERING TERMINAL		0769-82001899		
		www.xfconn.com		
		DWG NO: /		
APPD	Chen ZhiQiang	VIEW 		
CHKD	Liu Wei			
DRAW	Chen HongJiang	SCALE	SHEET	REV
DATE	2024.12.02	NONE	1/1	A1

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1	插脚		H62 (Y2)	1
序号	名称	零件编号	材质	数量